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Endorsed by American  
Electroplaters' Society  
Endorsed by National  
Association of Metal Finishers

## Standard Guide for Engineering Chromium Electroplating<sup>1</sup>

This standard is issued under the fixed designation B177/B177M; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon ( $\epsilon$ ) indicates an editorial change since the last revision or reapproval.

*This standard has been approved for use by agencies of the U.S. Department of Defense.*

### 1. Scope

1.1 This guide provides information about the deposition of chromium on steel for engineering uses. This is sometimes called “functional” or “hard” chromium and is usually applied directly to the basis metal and is usually thicker than decorative deposits.

1.2 The values stated in either SI units or inch-pound units are to be regarded separately as standard. The values stated in each system may not be exact equivalents; therefore, each system shall be used independently of the other. Combining values from the two systems may result in non-conformance with the standard.

1.3 This guide is not intended as a standardized procedure, but as a guide for obtaining smooth, adherent coatings of chromium of a desired thickness while retaining the required physical and mechanical properties of the base metals. Specified chromium electrodeposits on ferrous surfaces are defined in Specification B650.

1.4 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety and health practices and determine the applicability of regulatory limitations prior to use.*

1.5 *This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.*

<sup>1</sup> This guide is under the jurisdiction of ASTM Committee B08 on Metallic and Inorganic Coatings and is the direct responsibility of Subcommittee B08.03 on Engineering Coatings.

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### 2. Referenced Documents

#### 2.1 ASTM Standards:<sup>2</sup>

- B183 Practice for Preparation of Low-Carbon Steel for Electroplating
- B242 Guide for Preparation of High-Carbon Steel for Electroplating
- B244 Test Method for Measurement of Thickness of Anodic Coatings on Aluminum and of Other Nonconductive Coatings on Nonmagnetic Basis Metals with Eddy-Current Instruments
- B253 Guide for Preparation of Aluminum Alloys for Electroplating
- B254 Practice for Preparation of and Electroplating on Stainless Steel
- B281 Practice for Preparation of Copper and Copper-Base Alloys for Electroplating and Conversion Coatings
- B320 Practice for Preparation of Iron Castings for Electroplating
- B322 Guide for Cleaning Metals Prior to Electroplating
- B481 Practice for Preparation of Titanium and Titanium Alloys for Electroplating
- B487 Test Method for Measurement of Metal and Oxide Coating Thickness by Microscopical Examination of Cross Section
- B499 Test Method for Measurement of Coating Thicknesses by the Magnetic Method: Nonmagnetic Coatings on Magnetic Basis Metals
- B504 Test Method for Measurement of Thickness of Metallic Coatings by the Coulometric Method
- B507 Practice for Design of Articles to Be Electroplated on Racks

<sup>2</sup> For referenced ASTM standards, visit the ASTM website, [www.astm.org](http://www.astm.org), or contact ASTM Customer Service at [service@astm.org](mailto:service@astm.org). For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

- B558** Practice for Preparation of Nickel Alloys for Electroplating
  - B568** Test Method for Measurement of Coating Thickness by X-Ray Spectrometry
  - B571** Practice for Qualitative Adhesion Testing of Metallic Coatings
  - B578** Test Method for Microhardness of Electroplated Coatings
  - B602** Test Method for Attribute Sampling of Metallic and Inorganic Coatings
  - B630** Practice for Preparation of Chromium for Electroplating with Chromium
  - B650** Specification for Electrodeposited Engineering Chromium Coatings on Ferrous Substrates
  - B697** Guide for Selection of Sampling Plans for Inspection of Electrodeposited Metallic and Inorganic Coatings
  - B762** Test Method of Variables Sampling of Metallic and Inorganic Coatings
  - B849** Specification for Pre-Treatments of Iron or Steel for Reducing Risk of Hydrogen Embrittlement
  - B850** Guide for Post-Coating Treatments of Steel for Reducing the Risk of Hydrogen Embrittlement
  - B851** Specification for Automated Controlled Shot Peening of Metallic Articles Prior to Nickel, Autocatalytic Nickel, or Chromium Plating, or as Final Finish
  - F519** Test Method for Mechanical Hydrogen Embrittlement Evaluation of Plating/Coating Processes and Service Environments
- 2.2 *Military Standard*:<sup>3</sup>
- MIL-S-13165B** Shot Peening of Metal Parts

### 3. Substrates

3.1 Engineering chromium may be plated directly to the surface of a number of commonly used engineering metals such as aluminum, nickel alloys, cast iron, steels, copper, copper alloys, and titanium. The bond strengths of the chromium varies with metallic substrate. Nevertheless, if the procedures cited in the appropriate references are followed, the bond strength is such that grinding and honing can be conducted without delamination of the coating.

3.2 *Smoothness*—The smoothness of the material surface to be electroplated should be adequate to meet the requirements of the finished product. Chromium electrodeposits do not exhibit leveling, and consequently the surface roughness of the electrodeposit will always be greater than that of the substrate. Any mechanical operations that can result in grinding checks or glazing of the metal are detrimental and should be eliminated. The required surface smoothness may be obtained by suitable chemical, mechanical, or electrochemical procedures. Depending upon the thickness of the electrodeposit and the smoothness required of the electrodeposit, grinding of the electrodeposit may be required.

3.3 *Fatigue Considerations*—Cracking that can occur in chromium electrodeposits either as a function of the plating

bath chemistry or the plating conditions, or both, or as a result of grinding of the electrodeposit can lead to a reduction in the fatigue life of the electroplated part. If this is a design consideration, the use of mechanical methods such as shot peening (see Specification **B851** or MIL-S-13165C, or both) or autofrettage to compressively stress the surface can increase the fatigue strength. This should be done after any stress-relieving heat treatment.

#### 3.4 *High-Strength Steel Stress Relief*:

3.4.1 All steel parts having an ultimate tensile strength of 1000 MPa [150 000 psi, approximately 32 HRC] or greater, which may contain residual stress caused by various fabrication operations such as machining, grinding, straightening, or cold-forming, usually will require one of the stress relief bakes prescribed in Specification **B849** prior to electroplating. In all cases, the duration of the bake shall commence from the time at which the whole of each part attains the specified temperature. This stress relief is essential if hydrogen embrittlement from subsequent operations is to be avoided.

3.4.2 Parts having surface-hardened areas that would suffer an unacceptable reduction in hardness by baking in accordance with Specification **B849** may be baked at a lower temperature but not less than 130°C for a minimum period of 8 h. Shorter times at higher temperatures may be used, if the resulting loss in surface hardness is acceptable.

3.5 *Oxidation*—All possible precautions should be taken to prevent oxidation of the metal surface between the final operations of mechanical preparation and electroplating, particularly with steel substrates. Materials such as aluminum and titanium have an inherent oxide film on the surface that can only be removed or minimized just prior to the electroplating process (see 6.1.1 and 6.1.2). When conditions are especially unfavorable, definite steps must be taken to meet this important requirement, including storage in a noncorrosive environment, or the use of a suitable coating to exclude air and moisture.

### 4. Racks and Anodes

4.1 Steel, cast iron, and stainless steel parts to be electroplated may be racked at any convenient stage in the preparatory process but preferably prior to the final cleaning and etching. Aluminum, titanium, and certain nickel alloys may need to have cleaning and etching operations done before racking due to entrapment of cleaning and etching solutions in the plating rack which can result in adhesion failures due to seepage during chromium electroplating.

4.2 See Practice **B507** for guidance on rack design, but note that while the general principles of good racking as used in other electroplating processes apply, the use of much higher current densities and the desirability of securing coatings of uniform thickness and quality on desired areas require rack construction designs and methods that are much more exacting. The design of racks for chromium electroplating on the various base metals previously mentioned for functional use should provide for the following to the greatest possible extent.

4.2.1 There must be sufficient current-carrying capacity of both cathode and anode circuits to all parts of the rack.

4.2.2 There must be positive electrical contact to the parts to be electroplated, to the anodes, and to the tank contact bus bars.

<sup>3</sup> Available from Standardization Documents Order Desk, Bldg. 4 Section D, 700 Robbins Ave., Philadelphia, PA 19111-5094, Attn: NPODS.

4.2.3 There must be uniform current distribution on the parts to be electroplated. This often requires anodes of special shapes conforming to the shape of the part or area to be electroplated.

4.2.4 It may be necessary to use thieves, robbers, or guards, which are auxiliary metallic conductors placed near points of abnormally high current density to attract the current away from such points; and shields, which are parts made of nonconductive materials and placed to disperse the current in areas where it tends to concentrate unduly.

4.2.5 It is important to protect areas that are to remain free of any chromium electroplate by the use of masks made of rigid, nonconductive materials placed against the substrate, or stop-offs, which are especially compounded nonconductive tapes, waxes, lacquers, or plastics for the protection of such substrates. Lead and aluminum tapes will provide a sharp line of demarcation between coated and uncoated areas with a minimum of buildup.

4.2.6 Plugs (conducting and nonconducting) may be used in holes not requiring electroplating to produce a sharp edge without grooves around the periphery of the holes.

4.2.7 It is very important to remember that improperly applied stop-off materials or poorly designed racks can entrap acids that can cause corrosion of the basis material or contamination of the solutions used in subsequent operations, or both.

4.2.8 Construction materials must be used that are sufficiently insoluble and noncontaminating to provide the desired rack life.

4.2.9 Components must be placed in such positions that gas from the parts, rack, thieves, masks, and anodes escapes freely and does not become entrapped so as to prevent electroplating on areas that should be electroplated.

4.3 *Anodes*—Lead anodes containing 4 to 6 % antimony, 4 to 7 % tin, or 1 % silver, or a combination thereof, are satisfactory. Chemical lead is also satisfactory where hardness and rigidity are not important. However, it tends to form great quantities of scale that may fall off on the work and cause pitting or roughness. Lead wire used for small anodes should contain 0.25 % antimony to obtain the best relationship between rigidity and ductility in close tolerance areas. Lead-sheathed steel, copper, or silver may be used when indicated by requirements for strength or conductivity. Platinum, platinum-clad niobium, or even steel rods or wire may be used for internal electroplating of small holes, but the latter will contaminate the bath with iron. If the anode contains little or no lead, the reoxidation of trivalent chromium to the hexavalent state will not take place or will be seriously impaired, which will lead to trivalent buildup in the plating solution and poor results.

4.3.1 Some proprietary baths may require special anodes, which should be recommended by the supplier.

## 5. Cleaning

5.1 Parts to be electroplated may be cleaned in accordance with Practices B183, B242, B254, B281, B320, B322, B481, B558, or B630, or Guide B253.

5.2 Mechanical methods of cleaning steel prior to electroplating, including abrasive blasting or light grinding, are

also suitable. If parts have been shot-peened to develop a compressively stressed surface, it is important to avoid removing that surface by excessive grinding.

## 6. Deoxidizing and Etching

6.1 Prior to chromium electroplating, most metals need special preparation in order to achieve maximum adhesion of the chromium to the substrate. Depending on the type and nature of the metal and prior surface preparation steps, various deoxidation and etching methods may be used to activate the substrate prior to chromium electroplating.

6.1.1 *Aluminum*—Chromium may be electroplated directly onto most cast and wrought aluminum materials used for engineering purposes. Guide B253 offers many useful methods for preparing aluminum prior to chromium electroplating. The removal of the ever-present, tenacious oxide film on the surface of aluminum is what makes electroplating difficult. When using test methods in which a zinc immersion film is applied to the aluminum surface for protection against oxide formation, the article to be plated must enter the chromium-plating solution under live current.

6.1.2 *Titanium*—Like aluminum, titanium has an ever-present tenacious oxide film that must be removed prior to plating. Practice B481 offers many ways to prepare titanium prior to chromium electroplating.

6.1.3 *Nickel Alloys*—Several different activation methods are available in Practice B558 for the preparation of different nickel alloys. The main difficulty with these materials when chromium plating is polarization of the nickel alloy surface prior to plating which results in deactivation of the material and skip plating.

6.1.4 *Copper and Copper Alloys*—Practice B281 offers many suitable methods for preparing copper and copper alloys prior to chromium electroplating. In general, only deoxidizing of the copper or copper alloy surface is necessary for chromium electroplating.

6.1.5 *Stainless Steel*—Practice B254 offers many suitable activating procedures for the preparation of stainless steel prior to chromium electroplating. Some stainless steels benefit from a Woods nickel strike prior to chromium electroplating. Polarized surfaces in high-nickel stainless steels can cause skip plating if not properly activated.

6.1.6 *Cast Iron*—Practice B320 offers many suitable procedures for activating cast iron prior to chromium electroplating. In general, anodic etching in the chromium plating solution is not recommended. Due to the high carbon content in iron castings, anodic etching leaves a carbon smut on the surface of the metal which results in poor adhesion of the chromium.

6.2 Chromium plating on steel is among the most common combination for engineering purposes. Unique activation procedures for steel exist with chromium plating that merit a separate discussion for successful plating as follows.

6.2.1 Etching of the steel before electroplating is ordinarily desirable to obtain satisfactory adhesion of the chromium to the steel. To reduce the increase in roughness resulting from etching, the etching times should be kept as short as is consistent with good adhesion, particularly in the case of highly finished surfaces.